

**Application Data Sheet**

**Application Information**

<b>Application Type::</b>	Regular
<b>Subject Matter::</b>	Utility
<b>Suggested classification::</b>	
<b>Suggested Group Art Unit::</b>	
<b>CD-ROM or CD-R?::</b>	None
<b>Computer Readable Form (CRF)?::</b>	No
<b>Title::</b>	CONDITION ANALYSIS APPARATUS
<b>Attorney Docket Number::</b>	028340-0102
<b>Request for Early Publication?::</b>	No
<b>Request for Non-Publication?::</b>	No
<b>Suggested Drawing Figure::</b>	
<b>Total Drawing Sheets::</b>	14
<b>Small Entity?::</b>	No
<b>Petition included?::</b>	No
<b>Secrecy Order in Parent Appl.?::</b>	No

**Applicant Information**

<b>Applicant Authority Type::</b>	Inventor
<b>Primary Citizenship Country::</b>	Japan
<b>Status::</b>	Full Capacity
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<b>Family Name::</b>	SATO
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<b>Country of Residence::</b>	Japan
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**City of mailing address::** Yokohama-shi  
**State or Province of mailing address::** Kanagawa  
**Country of mailing address::** Japan  
**Postal or Zip Code of mailing address::** 2230061

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**State or Province of mailing address::** Tokyo  
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**Applicant Authority Type::** Inventor  
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<b>Postal or Zip Code of mailing address::</b>	1028465
<b>Applicant Authority Type::</b>	Inventor
<b>Primary Citizenship Country::</b>	Japan
<b>Status::</b>	Full Capacity
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<b>Postal or Zip Code of mailing address::</b>	1028465
<b>Applicant Authority Type::</b>	Inventor
<b>Primary Citizenship Country::</b>	Japan
<b>Status::</b>	Full Capacity
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<b>Family Name::</b>	TAKESUE
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**Correspondence Information**

**Correspondence Customer Number::** 22428  
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**Representative Information**

<b>Representative Customer Number::</b>	22428	
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**Domestic Priority Information**

<b>Application::</b>	<b>Continuity Type::</b>	<b>Parent Application::</b>	<b>Parent Filing Date::</b>
This Application	National Stage of	PCT/JP2004/007716	06/03/2004

**Foreign Priority Information**

<b>Country::</b>	<b>Application number::</b>	<b>Filing Date::</b>	<b>Priority Claimed::</b>
Japan	2003-163502	06/09/2003	Yes

**Assignee Information**

**Assignee Name::** SUMITOMO OSAKA CEMENT CO., LTD.  
**Assignee Name::** KEIO UNIVERSITY